	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level pa	rts, the	declaratio	n encoi		er level mate	erials for v	which th	e item is an assembly le manufacturer has eclaration.
1/32-2 1.1		Web Site for Informat		-1752 Standa	rd		Form Type *Declaration Class *DistributeClass 6 - RoHS Yes/No, Homogeneous M					neous Ma	aterials	and Mfg Informat
Supplier Information														
Company Name * Company Unique ID				Unique ID Au	Response Date *				Response Doo					
SEMTECH CORPORATION 00-847-9941				DUNS		2016-10-13								
Contact Name * Roya Motamedi	Title - Contact Supervisor, QA Prod		Phone - Con 805-498-211	Email - Contact * rmotamedi@semtech.com			om	Duplicate Contact -> Authorized Representative						
Authorized Representati Roya Motamedi	Title - Representative Supervisor, QA Proc		-			Email - Representative * rmotamedi@semtech.con			Supplier Comr	nents or URI	for Addi	tional Ir	formation	
Requester Item Number	r	Mfr Item Number		Mfr Item Name	Effective Date		Version Manuf		cturing Site Weight *		UON	N	Unit Type	
	UClamp3381P.TFT			High Power µClamp 3.3V ESD			& China			0.677		mg		Each
Alternate Recommenda	ation				Alternate Item C			omments				•		
Manufacturing Proces	ss In	formation												
Terminal Plating / Grid Array I	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	ating P	eak Proc	ess Body	Temper	rature Max Time	at Peak Tem	perature N	lumber o	of Reflow Cycles
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy			,	1				260 C	;	30 se	econds 3	3		
UClamp3381P.TFT is RE	АСН	-compliant product	, per EU R	egulation EC	:1907/2006 to inc	lude rec	ent add	ition of s	SVHC	candidate list	of substanc	es in Jur	ne 2016	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	town - town

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category	ory		Substance	CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM
	Name		Material	Weight	Measure			oubstance outegoly			oubstance					-	+	
+I -I	Die	+M -M	Doped	0.08	mg	+C -C	Supplier	Die	+S	-S	Si	7440-21-3		0.0708	mg			104,65
		_				+C -C	Supplier	Copper Pillar	+S	-S	Cu	7440-50-8		0.0053	mg			7,798
									+S	-s	Sn	7440-31-5		0.0001	mg			5,095
									+S	-s	Ag	7440-22-4		0.0001	mg			104
+ -	Substrate	+M -M	Substrate strip	0.265	mg	+C -C	Supplier		+S	-S	Solder mask	Proprietary		0.0221	mg			32,724
		_							+S	-s	вт	65997-17-3		0.1116	mg			164,87
									+S	-s	Copper	7440-50-8		0.1018	mg			150,40
						+C -C	в	Nickel (external applic	;+S	-s	Nickel	7440-02-0		0.0281	mg			41,481
						+C -C	Supplier		+S	-S	Au	7440-57-5		0.001	mg			1,486
+ -	Molding compound	+M -M	EME-G760L	0.333	mg	+C -C	Supplier		+S	-s	Silica (Amorphous) A	60676-86-0		0.2577	mg			380,81
		_							+S	-s	Silica (Amorphous) B	7631-86-9		0.0266	mg			39,310
									+S	-s	Epoxy resin	Proprietary		0.0266	mg			39,310
									+S	-s	Phenol resin	Proprietary		0.01	mg			14,741
									+S	-s	Metal Hydroxide	Proprietary		0.01	mg			14,741
									+S	-S	Carbon black	1333-86-4		0.0017	mg			2,457